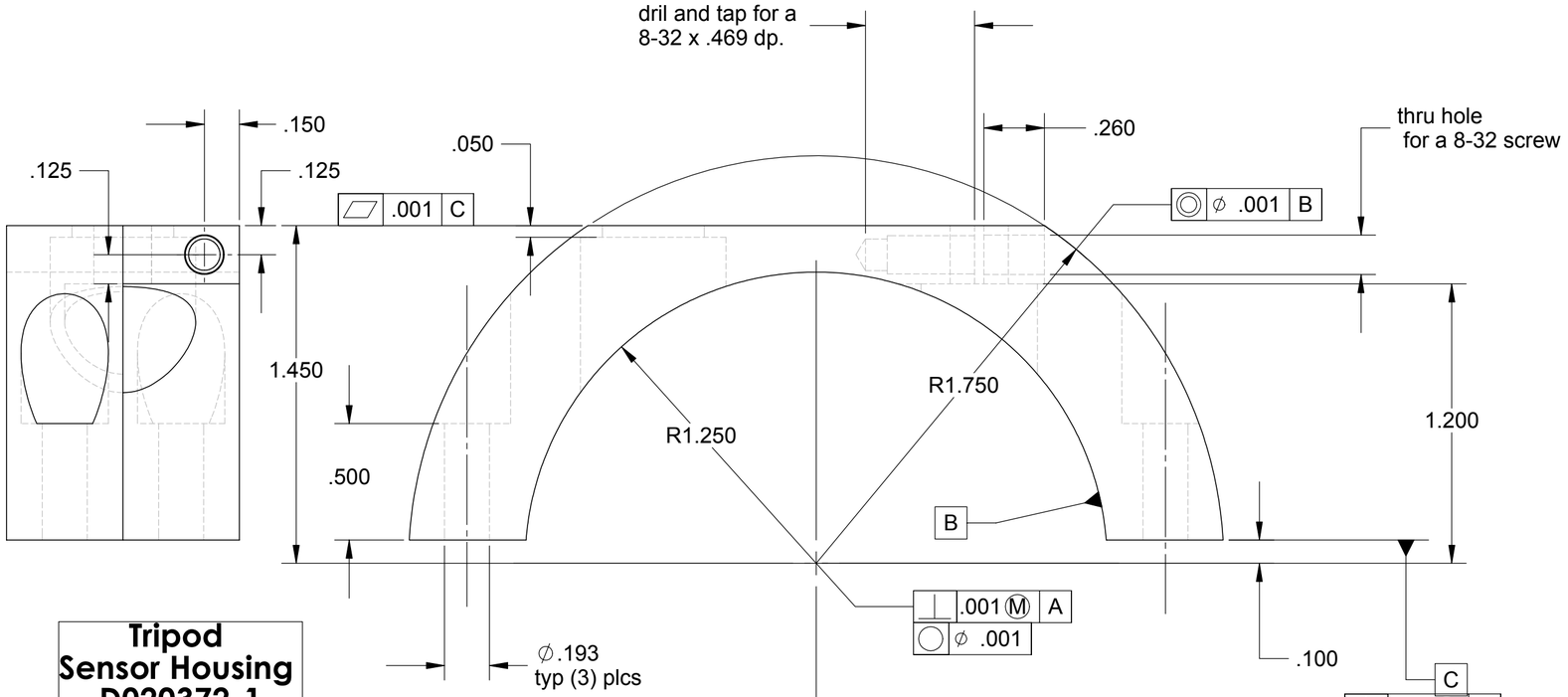
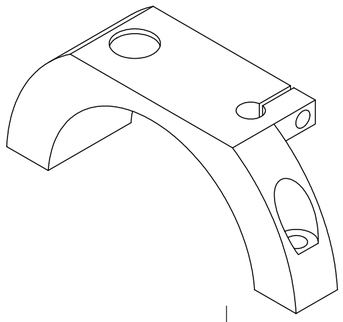
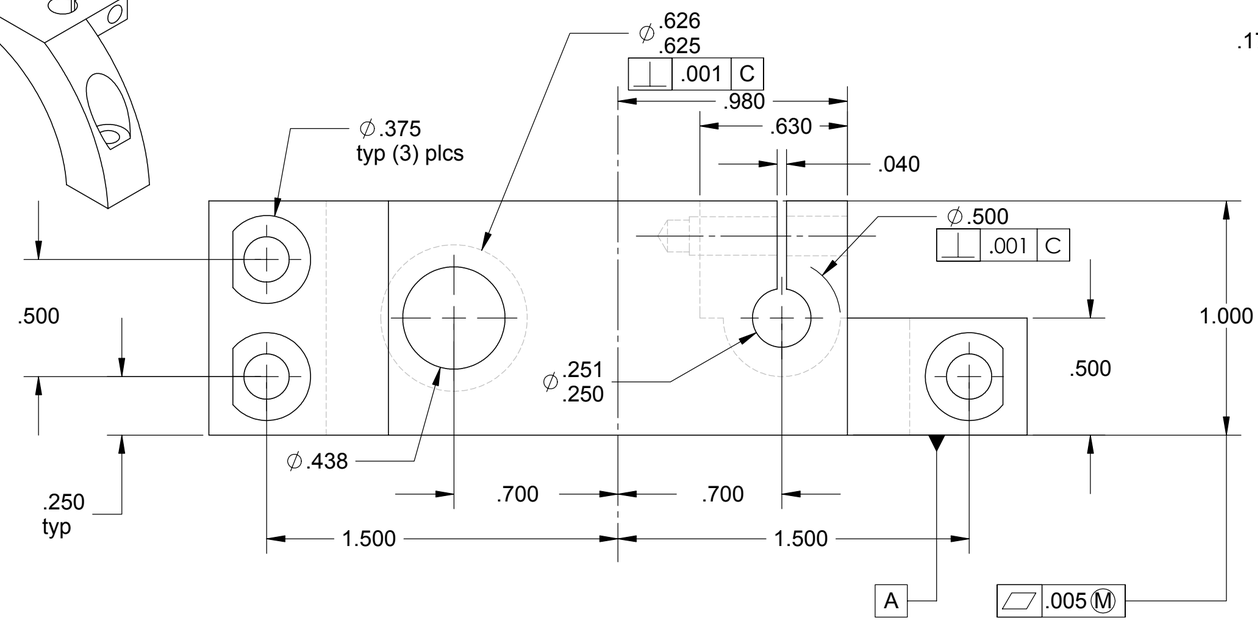
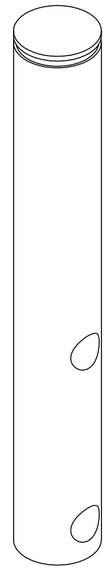
REV.	DATE	DCN #	DRAWING TREE #
A	2/9/2003		



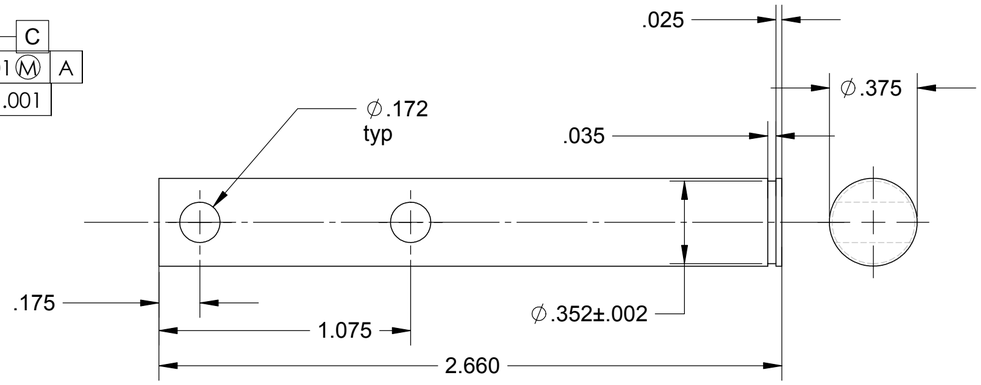
Tripod
Sensor Housing
D020372-1
(1) required
mat'l: 6061-T6



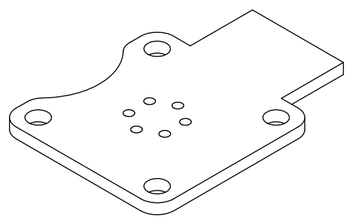


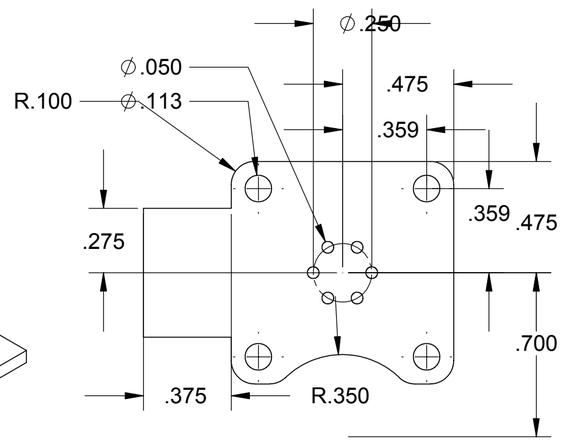


Tripod
Sensor Post
D020372-2
(1) required
use Thompson Rod
(hardened and ground)



L4C
Circuit Board
(1) required
D020372-3





UNLESS OTHERWISE SPECIFIED:		DATE	NAME
DIMENSIONS ARE IN INCHES	DRAWN	4/02	Hardham
TOLERANCES: .XX ± 0.020"	REDRAWN	1/15/03	Hammond
.XXX ± 0.005"	CHECKED	2/9/03	Kern
ANGULAR ± 30'			
MATERIAL 304 L	COMMENTS:		
FINISH 32 RMS UNLESS NOTED			

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SYSTEM	LASTI
SUB-SYSTEM	HEPI
NEXT ASSY	
PART NAME	HEPI Tripod Sensor Housing, Sensor Post, and Circuit Board
SIZE C	DWG. NO. D020372-A-E
REV	A
SCALE:	1:1 UNLESS NOTED

FILE NAME/LOCATION: